

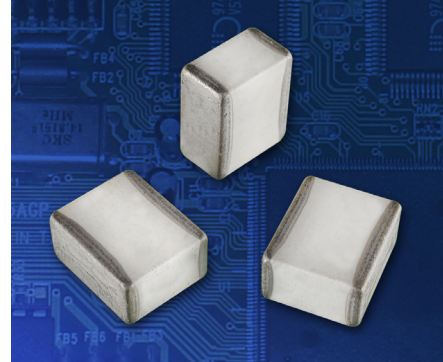
EIA 1111 High Power Capacitors (S42E Silver Series) Specification

1.0 Scope

This capacitor belongs to the Silver Series family and is based on SMD Multilayer Ceramic technology. JTI uses nearly pure Silver electrodes while our competitors use Palladium electrodes. Silver is a much superior conductor when compared to Palladium. JTI Silver Series provides customers with a significant performance improvement and a more competitive cost. This specification is an in-depth look at the JTI High-Q Silver Series MLCC product line for all authorized JTI personnel (this document is company confidential). This document will educate the reader on all important aspects of High-Q capacitor recognition, proper application and design utilization.

2.0 Applications

- Communications amplifiers
- Power converters
- Filter Networks
- Circuit Matching
- Amplitude modulators
- Antenna Matching, high power circuitry
- Decoupling, Bypass, & DC Block



2.1 Market Segments (Typical End Applications)

The Silver Series products are used to improve the performance of nearly all high frequency circuits. Below is a list of typical applications where Silver Series capacitors are widely used:

- High Power RF Systems
- High Voltage RF Systems
- Cellular Base Station Equipment
- Medical MRI (Non-Magnetic)
- RF Heater (Industrial) systems
- Teat Equipment (Power Amplifiers)
- Military Radar and Jamming Electronics

3.0 Features:

- Excellent temperature dissipation (for High Power Temp Rise)
- Excellent Power Handling Capabilities
- High stability dielectric (NPO)
- One of the best equivalent series resistance (ESR) of its kind due to newly-formulated internal electrodes and low loss dielectrics Industry leading High-Q/Low loss COG (NPO) performance
- Manufacturing controls that ensure consistency lot to lot and year to year
- Green and RoHS compliance
- Gold (Au), Non-Magnetic Copper (Cu), Tin (Sn and Sn/Pb and leaded terminations are available
- EIA Marking is available

4.0 Basic Construction

Magnetic (Ni) and Non-Magnetic (Cu) Barrier Termination

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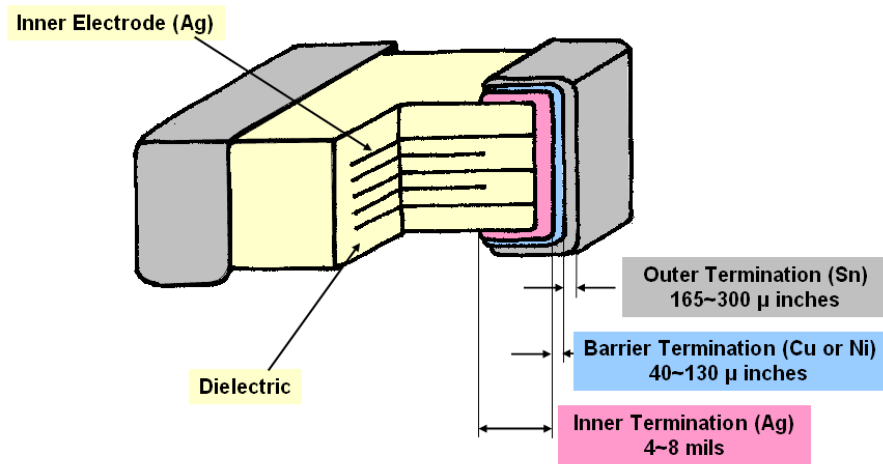


Figure 1 Termination Cross Section

5.0 Electrical Characteristics

Dielectric	NPO
Rated Voltage (VDC)	50 to 1000 Volts DC (See section 9.0 for details)
Capacitance Range (EIA)	0.2 to 1000 pF (See section 9.0 for details)
Capacitance Tolerance	A, B, C, D, F, G, J, K, M
Test Parameters	1 MHz ± 50 kHz @ 1.0 ± 0.2 VRMS, 25°C
Temperature Coefficient	0% ± 30 ppm/°C
Quality Factor	Q > 1,000 at 1 MHz ± 50 kHz, 25°C, 1.0 ± 0.2 VRMS
Insulation Resistance	1000 GΩ - 1pF-470pF 100GΩ - 510pF-1000pF
Operating Environment Range	-55 to 125°C
Storage Environment Range	Tape & Reel: -5 to 40°C & 15 to 75% RH
Breakdown Voltage	> 2.5 x WVDC Min., 25°C, 50 mA Max

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6.0 Material and Physical Specifications

No	Item		Performance	Test Condition
1	Appearance		No abnormal exterior appearance.	Through Microscope (30x) or Automatic Vision Inspection System
2	PCB Deflection		Visual Criteria – No mechanical damage shall occur	Glass Epoxy PCB → 0.5 mm Deflection
3	Solderability MIL-STD-202 J-STD-002		More than 90% of the terminal surface is to be soldered newly so the metal parts do not come out or dissolve.	Solder Temperature: 240 ± 5°C Dip Time: 5 seconds
			Wetting force of 2/3 F _{max} must be achieved in 1.0 s or less.	Solder: SN 62 Flux: Rosin Pre-heating: 120 to 150°C for 60 seconds Flux: Actiec 5 or equivalent
			Capacitance Change Criteria – Change of capacitance within ± 2% or ± 0.5 pF whichever is larger.	Solder Temperature: 235 °C
4	Adhesive Strength of Termination MIL-STD-202		Termination should not pull off and ceramic should remain undamaged	Linear pull force exerted on axial leads soldered to each terminal. 5 lbs. Minimum
5	Resistance to soldering heat MIL-STD-202G METHOD 210F	Appearance	No Mechanical Damage	Solder Dip Criteria: Solder Temperature of 260 ± 5°C Solder dip duration: 10 ± 1 Second

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No	Item	Performance	Test Condition	
	Resistance to soldering heat MIL-STD-202G METHOD 210F	Appearance	No Mechanical Damage	Each termination shall be fully preheated and immersed as follows: Step 1.) 80 – 100°C for 60 Seconds Step 2.) 150 – 180°C for 60 Seconds Measurements are completed at room temp. after cooling for 24±2 Hrs
		Capacitance	Capacitance change within ± 2.5 % or ± 0.25pF whichever is larger	
		Q	Q > 500	
		Insulation resistance	1000 GΩ-1pF-470pF 100GΩ-510pF-1000pF	
		Breakdown Voltage	> 2.5 x WVDC Min., 25°C, 50 mA Maximum	
6	Vibration Test MIL-STD-202G METHOD 201A	Appearance	No Mechanical Damage	The capacitor shall be subjected to a harmonic motion having a total amplitude of 1.5 mm. The entire frequency range from 10 to 55 Hz and a return to 10 Hz shall be traversed in one minute. The cycle shall be performed for 2 hours in each perpendicular direction for a total of 6 hours.
		Capacitance	Within ± 2.5% or ± 0.25pF whichever is larger	
		Q	Q > 1000	
		Insulation Resistance	1000 GΩ-1pF-470pF 100GΩ-510pF-1000pF	
		Voltage Breakdown	> 2.5 x WVDC Min., 25°C, 50 mA Maximum	
7	Humidity (Steady State) MIL-STD-202 METHOD 103A	Appearance	No Mechanical Damage	Temperature: 40 ± 2°C Relative Humidity: 90 to 95 % Test Time: 500 +12 / -0 Hr.
		Capacitance	Within ± 5% or ± 0.5pF whichever is larger	
		Q	Q > 300	

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No	Item	Performance	Test Condition
7	Humidity (Steady State) MIL-STD-202 METHOD 103B	Insulation Resistance	> 10 GΩ
		Voltage Breakdown	> 2.5 x WVDC Min., 25°C, 50 mA Maximum
Measured at room temperature after cooling for 24 ± 2 Hr.			
8	Moisture Resistance MIL-STD-202	Appearance	No Mechanical Damage
		Capacitance	Within ± 7.5% or ± 0.75 pF whichever is larger
		Q	Q > 300
		Insulation Resistance	Minimum Insulation Resistance: 1 Ω
		Voltage Breakdown	> 2.5 x WVDC Min., 25°C, 50 mA Maximum
Applied Voltage: 1.5 Volts Temperature: 85 ± 2°C Relative Humidity: 85 % Test Time: 240 +12 / -0 Hr. Current Applied: 50 mA max. Measured at room temperature after cooling for 24 ± 2 Hr.			
9	High Temperature Resistance (Life) MIL-STD-202 METHOD 108 Condition D	Appearance	No Mechanical Damage
		Capacitance	Within ± 3% or ± 0.3pF Whichever is larger
		Q	Q > 500
		Insulation Resistance	Minimum Insulation Resistance: 1 GΩ
		Voltage Breakdown	> 2.5 x WVDC Min., 25°C, 50 mA Maximum
Applied Voltage: 200% of Rated Voltage Test Time: 1000 +48 / -0 Hr. Current Applied: 50 mA MAX. Temperature: 125 ± 3°C			
10	Temperature Cycling MIL-STD-202	Appearance	No Mechanical Damage
Capacitors shall be subjected to five (5) cycles of temp cycle profile: <i>Step 1.)</i> Minimum rated temperature +0 / -3°C for 30 minutes			

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EIA 1111 High Power Capacitors (S42E Silver Series) Specification

No	Item	Performance	Test Condition
10	Temperature Cycling MIL-STD-202	Appearance	No Mechanical Damage
		Capacitance	Within $\pm 2.5\%$ or ± 0.25 pF whichever is larger
		Q	$Q > 1000$
		Insulation Resistance	To satisfy the initial criteria
		Voltage Breakdown	$> 2.5 \times$ WVDC Min., 25°C, 50 mA Maximum
		<i>Step 2.)</i> 25°C for 2-3 minutes <i>Step 3.)</i> Maximum rated temperature $+3/ -0^\circ$ for 30 minutes <i>Step 4.)</i> 25°C for 2-3 minutes Measurements shall be made after the capacitors cool for 24 ± 2 hours.	
11	Reflow soldering requirement	To withstand the reflow soldering profile 3-times and meet sec. 1 - 5 & 13	See reflow soldering profile and specifications (3x).
12	Underfiller curing profile	To withstand the reflow soldering profile 2 times (2x) followed by a minimum of 5 minutes at temperature, and meet sec. 1 - 5 & 13	See reflow soldering profile and specifications (2x). Temperature: $150 \pm 10^\circ\text{C}$ Time at temp.: 5 min
13	Manual hot gas soldering requirement	To withstand hot gas soldering for rework at the specified temperature, air velocity, and time, and, meet the requirements of sec. 1 - 5 & 13	Max Air Temperature: 260 °C Max Air Velocity: 10 m/s Max Exposure Time: 30 s
14	Manual soldering using soldering iron requirement	To withstand manual soldering using soldering iron for rework at the specified temperature and time, and, meet the requirements of sec. 1 - 5 & 13	Tip Diameter: To fit application Max Tip Temperature: $260 \pm 10^\circ\text{C}$ Max Exposure Time: 3 seconds

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7.0 Part Number Code

501	S42	E	1R0	C	V	4	T
VOLTAGE CODE	PART SIZE	EIA EQUIV	CAPACITANCE CODE:	TOLERANCE CODE:	TERMINATION CODE		PACKAGING CODE
1st 2 digits are significant, 3rd digit denotes the number of zeros to follow. eg: 500 = 50 VDCW R denotes decimal	S42 S48 S58	1111 2525 3838	1st 2 digits are significant, 3rd digit denotes the number of zeros to follow eg: 331 = 330 pF R denotes decimal eg: 1R0 = 1.0 pF	**A = ± 0.05 pF *B = ± 0.1 pF *C = ± .25 pF *D = ± .50 pF F = ± 1.0% G = ± 2.0% J = ± 5.0%	Nickel Barrier V = Ni/Sn (Green) T = Ni/SnPb G = Ni/Au (Green)		E = Embossed 7" reel Z = Embossed 5" reel U = Embossed 13" Reel
<i>Standard Voltages</i> 500 = 50 VDCW 101 = 100 VDCW 201 = 200 VDCW 301 = 300 VDCW 501 = 500 VDCW 102 = 1000 VDCW 252 = 2500 VDCW 362 = 3600 VDCW 722 = 7200 VDCW	DIELECTRIC CODE E = Low Loss NPO ±30 ppm, -55 TO +125°C			For Values: * <10pF Only ** <5pF Only	Non-Mag S = Cu/Sn (Green) C = Cu/SnPb		MARKING CODES: 3 = Cap Code & Tol 4 = Not marked 6 = EIA Marking
					Leaded (All Non-Mag) 1 = Microstrip 2 = Axial Ribbon 3 = Axial Wire 4 = Radial Ribbon 5 = Radial Wire		

8.0 Dimensions

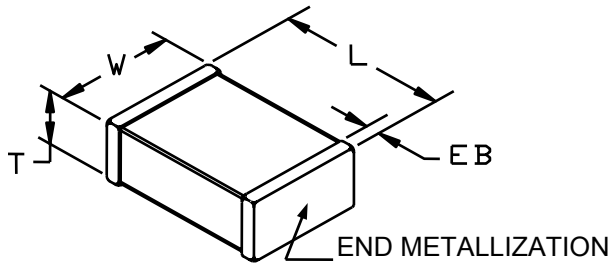


Figure 2 Basic Construction

Component Size in mm

		S42
Length	Min.	2.54
	Max	3.3
End-band	Min.	0.33
	Max	0.43
Width	Min.	2.28
	Max	3.3
Thickness	Max	2.59

Component Size in Inches

		S42
Length	Min.	0.100
	Max	0.130
End-band	Min.	0.013
	Max	0.017
Width	Min.	0.090
	Max	0.130
Thickness	Max	0.102

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9.0 Capacitance Range

pF	Cap Code	Tolerance	Standard Voltage	Extended Voltage	pF	Cap Code	Tolerance	Standard Voltage	Extended Voltage
0.5	0R5	A	500V	1500V	36	360	F	500V	1500V
0.6	0R6		500V	1500V	39	390		500V	1500V
0.7	0R7		500V	1500V	43	430		500V	1500V
0.8	0R8		500V	1500V	47	470		500V	1500V
0.9	0R9		500V	1500V	51	510		500V	1000V
1	1R0		500V	1500V	56	560		500V	1000V
1.1	1R1		500V	1500V	62	620		500V	1000V
1.2	1R2		500V	1500V	68	680		500V	1000V
1.3	1R3		500V	1500V	75	750		500V	1000V
1.4	1R4		500V	1500V	82	820		500V	1000V
1.5	1R5		500V	1500V	91	910		500V	1000V
1.6	1R6		500V	1500V	100	101		500V	1000V
1.7	1R7		500V	1500V	110	111		300V	1000V
1.8	1R8		500V	1500V	120	121		300V	1000V
1.9	1R9		500V	1500V	130	131		300V	1000V
2	2R0		500V	1500V	150	151		300V	1000V
2.1	2R1		500V	1500V	160	161		300V	1000V
2.2	2R2		500V	1500V	180	181		300V	1000V
2.4	2R4		500V	1500V	200	201		300V	1000V
2.7	2R7	500V	1500V	220	221	200V	N/A		
3	3R0	500V	1500V	240	241	200V	N/A		
3.3	3R3	500V	1500V	270	271	200V	N/A		
3.6	3R6	500V	1500V	300	301	200V	N/A		
3.9	3R9	500V	1500V	330	331	200V	N/A		
4.3	4R3	500V	1500V	360	361	200V	N/A		
4.7	4R7	500V	1500V	390	391	200V	N/A		
5.1	5R1	B	500V	1500V	430	431	200V	N/A	
5.6	5R6		500V	1500V	470	471	200V	N/A	
6.2	6R2		500V	1500V	510	511	100V	N/A	
6.8	6R8		500V	1500V	560	561	100V	N/A	
7.5	7R5		500V	1500V	620	621	100V	N/A	
8.2	8R2	C	500V	1500V	680	681	50V	N/A	
9.1	9R1		500V	1500V	750	751	50V	N/A	
10	100		500V	1500V	820	821	50V	N/A	
12	120	D	500V	1500V	910	911	50V	N/A	
13	130		500V	1500V	1000	102	50V	N/A	
15	150		500V	1500V					
16	160		F	500V	1500V				
18	180		G	500V	1500V				
20	200		J	500V	1500V				
22	220		K	500V	1500V				
24	240		M	500V	1500V				
27	270		500V	1500V					
30	300		500V	1500V					
33	330		500V	1500V					

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10.0 Electrical Testing

All parts are 100% tested for capacitance, insulation resistance, dissipation factor.

11.0 Green and RoHS Compliance

Johanson Technology, Inc. (JTI) is committed to reducing the lead content in all its product lines in an environmentally responsible, technologically feasible, and cost-effective manner without sacrificing the current high levels of performance, quality, and reliability. As a result, JTI has initiated lead-free research and development programs to identify and evaluate possible lead-tin solder substitutes, while working with suppliers and other companies to establish lead-free standards and testing requirements.

The S42E Silver Series Capacitor meets Green standards and accordingly, meets the Restriction of Hazardous Substances directive 2002/95/EC commonly referred to as RoHS. This family has lead free, 100% tin plated terminations, which does meet the RoHS directive. This does not include the optional termination code “T” which signifies tin-lead terminations.

12.0 Termination Types

The Silver Series product line is available in ten different termination types. These can be grouped into Nickel Barrier, Copper Barrier (Non-Magnetic) and Leaded termination types. The standard offering is a 100% matte Tin (Sn) with a Nickel barrier. Below is a summary of specific termination types:

Nickel Barrier

Code Termination Type

- V 100% Matte Tin (Sn) over Nickel Barrier
- T Tin Lead (SnPb) over Nickel Barrier
- G Gold (Au) over Nickel Barrier

Copper Barrier

Code Termination Type

- S 100% Matte Tin (Sn) over Copper Barrier, Non-Magnetic
- C Tin Lead (SnPb) over Copper Barrier, Non-Magnetic

Leaded

Code Termination Type

- 1 Microstrip All Non-Magnetic
- 2 Axial Ribbon All Non-Magnetic
- 3 Axial Wire All Non-Magnetic
- 4 Radial Ribbon All Non-Magnetic
- 5 Radial Wire All Non-Magnetic

13.0 Storage Life

Chip component terminations should generally be protected from moisture

EIA 1111 High Power Capacitors (S42E Silver Series) Specification

All chip components including tape and reel, should be kept in an area where the temperature is between -5°C and 40°C and where the humidity is 15% to 75%.

The chip components should be used within one year.

The solderability of the chip components should be rechecked in the event that they are not used in 6 months.

Peel strength and shelf life of tape will remain within specification up to 1 year when stored.

14.0 Packaging Specifications

Chip capacitors are packaged in tape and reel, sealed in plastic bags, and placed in cardboard boxes filled with protective fluffs.

Tape and Reel Standard: EIA 481

14.1 Tape dimension specifications:

- Tape size, material and type: 8 mm, Plastic embossed tape.
- Sprocket hole pitch: 4.0 ± 0.1 mm.
- Component pitch: 4 ± 0.05 mm

14.2 Leader section (empty carrier & tape): 280 mm min.**14.3 Trailer section (empty carrier & tape): 280 mm min****14.4 Tape functional specifications:**

- Tape break force: 10 N min.
- Top cover tape strength: 10 N min.
- Top cover peel force & angle: 0.1 - 1.0 N at 165 -180°

14.5 Reel specifications:

- Reel diameter size: 7 in (2000 pieces)
- Optional Reel diameter size: 5 inch and 13 inch.

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15.0 Recommended Land Pattern

Appropriate pad design, solder application, and component orientation are all ingredients of a quality, defect-free soldering process. The Institute for Interconnecting and Packaging Electronic Circuits (IPC) through IPC-7351A has endorsed Land Pattern Calculator program from PCB Matrix. (This land pattern calculator can be downloaded at: <http://www.pcbmatrix.com/Products/LPSoftware/LPCalculator/>) The following recommended land patterns are directly from this program. This standard presents industry consensus on optimum dimensions based on empirical knowledge of fabricated land patterns. The standard also contains an excellent analysis of solder joints and their relation to component, PCB, and placement tolerances. (<http://www.ipc.org>).

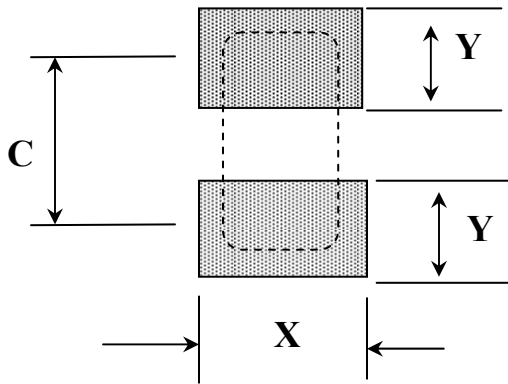


Figure 3 Land Pattern

JTI Size Code	Chip Size		C		Land X		Land Y	
			min	max	min	max	min	max
S42	1111	Inches	0.008	0.014	0.008	0.016	0.008	0.012
		(mm)	0.20	0.35	0.20	0.40	0.20	0.30

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Competitive Analysis

The key competitors for Silver Series are American Technical Ceramics (ATC), AVX, Dielectric Laboratories (DLI) and Murata.

Each company will be discussed in detail below:

ATC (www.atceramics.com)

- Competitive Products – ATC 100 Series (and 800 Series which is not fully released)
- ATC is strong in the medium and small volume high performance business.
- The 100 series provides lower ESR performance at frequencies above 150MHz, roughly the same from 75 to 150 MHz as the JTI Silver Series products.
- JTI Silver Series product is competitively priced (15% to 25%) lower than the ATC 100 series products
- The ATC part numbers break down as follows:

ATC: Example - 100B511JW100XT

Johanson Technology: 101S42E511JT6E

100	B	511	J	W	100	X	T
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ATC Model #	Size (EIA)	Capacitance	Tolerance	Termination	Voltage	Marking	Packaging
100	B (1111)	1st two digits are significant, third digit denotes number of zeros. R = decimal point.	A = ±0.05pF	W = SnPb over Ni	50 = 50V	Laser Marking	T = Tape and Reel
800	C (2525)		B = ±0.1pF	P = SnPb Coat over Ni	100 = 100V		1000 pc qty
	E (3838)		C = ±0.25pF	T = Sn over Ni	200 = 200V		C = Chip Pac
		1R0 = 1.0 pF	D = ±0.5pF	CA = Au over Ni	1000 = 1000V		100 pc Qty
		330 = 33 pF	F = ±1%	MS = Microstrip Leaded			I = Special
		471 = 470 pF	G = ±2%	AR = Axial Ribbon Leaded			Packaging
			J = ±5%	RR = Radial Ribbon Leaded			
			K = ±10%	RW = Radial Wire Leaded			
			M = ±20%	AW = Axial Wire Leaded			
				Non-Magnetic Terms			
				WN = SnPb Non Mag			
				PN = SnPb Coat Non Mag			
				TN = Sn Non Mag			
				MN = Microstrip Non Mag			
				AN = Axial Ribbon Non Mag			
				FN = Radial Ribbon Non Mag			
				RN = Radial Wire Non Mag			
				BN = Axial Wire Non Mag			

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AVX (www.avx.com)

- Competitive Products → Accu-P, Accu-F and U-Series
- We see AVX at larger volume accounts and rarely at small accounts.
- The Accu-P and Accu-F are a thin film capacitor – not MLCC. The performance is very good but the accu-Fs had a cracking problem a few years ago. The Accu-P and Accu-F are high cost.
- The U-Series is a low performance product when compared to the Silver Series. Price is also low. We need to be very aggressive on pricing to take U-Series business.
- It is important to have a competitive part number when competing with AVX products.
- The AVX part numbers break down as follows:

AVX Example: HQCCAA271JAT1A

Johanson Technology: 102S42E271JT4E

HQC	C	A	A	271	J	A	T	1	A
AVX Style High-Q Capacitor	Size (EIA) C (2525) E (3838)	Voltage 600V/630V = C 1000V = A 1500V = S 2000V = G 2500V = W 3000V = H 4000V = J 5000V = K 7200V = M	Temperature Coefficient C0G = A	Capacitance Code 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	Test Level A = Standard	Termination 1 = Pd/Ag T = Plated Sn on Ni (RoHS Compliant) J = 5% Min Pb	Packaging 1 = 7" Reel 3 = 13" Reel 9 = Bulk	Special Code A = Standard

Notes:
No Marking offered

AVX Example: AQ13EA100JA1ME

Johanson Technology: 102S42E271JC4E

AQ	13	E	A	271	J	A	T	1
AVX Style High-Q Capacitor	Size (EIA) 13 (2525) 14 (2525)	Voltage 5 = 50V 1 = 100V E = 150V 2 = 200V 9 = 300V 7 = 500V	Temperature Coefficient M = +90±20ppm/°C (AQ11/12/13/14) A = 0±30ppm/°C (AQ11/12/13/14) C = 15% ("J" Termination only) (AQ14)	Capacitance Code 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% N = ±30%	Failure Rate Code A=Not Applicable	Termination 1 = Pd/Ag (AQ11/13 only) 7 = Ag/Ni/Au (AQ11/13 only) J = Nickel Barrier Sn/Pb (60/40) - (AQ12/14 only) T = 100% Tin (AQ12/14 only)	Packaging 3A = 13" Reel ME = 7" Reel RE = 13" Reel WE = Waffle Pack

Notes:
No Marking offered

AVX Example: SQCB7M100JAT1A

Johanson Technology: 102S42E271JT4E

HQ	CC	A	A	271	J	A	T	1
AVX Style High-Q	Size (EIA) CB (1111)	Voltage 5 = 50V 1 = 100V E = 150V 2 = 200V V = 250V 9 = 300V 7 = 500V	Temperature Coefficient Coefficient Code M = +90±20ppm/°C A = 0±30ppm/°C C = 15% ("J" Termination only)	Capacitance Code 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	Failure Rate Code A=Not Applicable	Termination **1 = Pd/Ag **7 = Ag/Ni/Au J = Nickel Barrier Sn/Pb (60/40) **T = 100% Tin **RoHS Compliant	Packaging 1A = 7" Reel Unmarked 6A = Waffle Pack Unmarked ME = 7" Reel Marked WE = Waffle Pack Unmarked * Vertical T&R available * 500 piece reels available

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Notes:
No Marking offered

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AVX Example: HQLCAA271JAA

Johanson Technology: 102S42E271J24

HQL	C	A	A	271	J	A	A
AVX Style HQ Leaded	Size (EIA) C (2325) E (3838)	Voltage 600V/630V = C 1000V = A 1500V = S 2000V = G 2500V = W 3000V = H 4000V = J 5000V = K 7200V = M	Temperature Coefficient COG = A	Capacitance Code 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	Test Level A = Standard	Lead Type A = Axial Ribbon M = Microstrip

Notes:
 Non-Magnetic
 No Marking offered
 No Packaging Specified

AVX Example: CDR13BP101AKNS

Johanson Technology: 101S42E511KG4

CDR	13	BP	101	A	K	N	M
AVX MIL STYLE CDR	Size (EIA) 13 (1111) 14 (1111)	Dielectric Type BG = P90 BP = NPO	Capacitance 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Voltage A = 50V B = 100V C = 200V D = 300V E = 500V	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	Termination M = Palladium/Silver (CDR11 & 13 only) N = Silver, Nickel, Gold (CDR11 & 13 only) S = Solder Coated, Final (CDR12 & 14 only) U = Base Metallization, Barrier Metal, Solder Coated. (Solder M.P. 200°C or less) (CDR12 & 14 only) W = Base Metallization, Barrier Metal, Tinned (Tin or Tin/Lead Alloy) (CDR12 & 14 only) Y = 100% Tin Z = Base Metallization, Barrier Metal (Tin Lead Alloy With 4% Lead Min.)	Failure Rate Level M = 1.0% P = .1% R = .01% S = .001%

Notes:
 JTI is COTS equivalent
 No Marking offered
 No Packaging Specified
 Failure Rate Level not specified on JTI products

DLI (www.dilabs.com)

- Competitive Products → C04 (0402), C06 (0603) and C08 (0805)
- Performance is good but production capacity is limited and cost is high.
- It is rare that we see DLI in large volume accounts
- The DLI part numbers break down as follows:

EIA 1111 High Power Capacitors (S42E Silver Series) Specification

DLI (Old System) Example: C17CF101J4UX-T

Johanson Technology: 101S42E101JT4E

C	17	AH	101	J	4	U	X	-	T
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Product Type	Size (EIA)	Material	Capacitance	Tolerance	Voltage	Termination	Test Level	Marking	Packaging
Multilayer Cap	17 (1111) 18 (1111) 22 (2225) 40 (3838)	AH = P90 CF = NPO High-Q MS = NPO High-Q UL = Ultra Low ESR BL = DC Blocking	1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% X = GMV	5 = 50 V 1 = 100 V 8 = 150 V 6 = 200 V 9 = 250 V 3 = 300 V 4 = 500 V 7 = 1000 V A = 1500 V B = 2500 V D = 3600 V H = 7200 V	U = Ni Barrier, Solder Plate P = Ag Barrier, Palladium Flash Z = Lead Free Ni Barrier, Sn Plate S = Ni Barrier, Au Flash	X = Standard Level 2 A = MIL-PRF-55681 Group A C = MIL-PRF-55681 Group C D = Per Customer Dwg	- = No Laser Mark L = Single Side Mark D = Double Side Mark V = Vertical only MS and UL Parts cannot be Laser Marked	T = Tape Horizontal V = Tape Vertical W = Waffle Pack B = Bulk

Notes:
Test Level offered as a special at JTI
Vertical Tape and Reel offered as a special at JTI

DLI New System Example: C17AH101J-7UN-X0T

Johanson Technology: 102S42E101JT6E

C	17	CF	101	J	-	7	U	N	-	X	0	T
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Product Type	Size (EIA)	Material	Capacitance	Tolerance	Voltage	Termination	Leading Code	Test Level	Laser Marking	Packaging
Multilayer Capacitor	17 (1111) 18 (1111) 22 (2225) 40 (3838)	AH = P90 CF = NPO High-Q MS = NPO High-Q UL = Ultra Low ESR BL = DC Blocking	1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20% X = GMV	5 = 50 V 1 = 100 V 8 = 150 V 6 = 200 V 9 = 250 V 3 = 300 V 4 = 500 V 7 = 1000 V A = 1500 V B = 2500 V D = 3600 V H = 7200 V	T = Ag Termination, Ni Barrier Layer, Heavy SnPb Plated Solder F = Radial Wire P = AgPd Termination RoHS R = Ag Termination, Cu Barrier Layer, Heavy SnPb Plated Solder V = Ag Termination, Cu Barrier Layer, SnPb Plated Solder W = Ag Termination, Cu Barrier Layer, Sn Plated Solder RoHS M = Polymer Termination, Cu Barrier Layer, Sn Plated Solder RoHS Z = Ag Termination, Ni Barrier Layer, Sn Plated Solder RoHS S = Ag Termination, Ni Barrier Layer, Gold Flash RoHS U = Ag Termination, Ni Barrier Layer, SnPb Plated Solder	A = Axial Ribbon F = Radial Wire E = Axial Wire D = Custom C = Center Ribbon B = Radial Ribbon N = None	X = Standard Level 2 Y = Reduced Visual A = MIL-PRF-55681 Group A C = MIL-PRF-55681 Group C D = Per Customer Dwg	0 = No Laser 1 = Single Side 2 = Double Side 3 = Large Single Side 4 = Large Double Side 5 = Vertical Edge 9 = Custom	T = Tape and Reel Horizontal V = Tape and Reel Vertical W = Waffle Pack B = Bulk P = Plastic Box R = Tube (Rail) S = Custom

Notes:
Test Level offered as a special at JTI
Vertical Tape and Reel offered as a special at JTI

Temex Ceramics (www.temex-ceramics.com)

- Competitive Products → CPX, CPE, CLX, CLE Series products
- Temex is a strong competitor particularly in Europe.
- Temex parts perform well and are priced similar to ATC.
- The Temex part numbers break down as follows:

EIA 1111 High Power Capacitors (S42E Silver Series) Specification

Temex Example: 362CPX100GC1L

Johanson Technology: 362S42E100G16

362	CP	X	100	G	C	1		L	
Voltage 301=300V 501=500V 122=1.2KV 152=1.5KV 252=2.5KV 382=3.8KV	Dielectric CP = High-Q P100 Dielectric CL = High-Q NPO Dielectric	Case Size X (1111) E (3838)	Capacitance 1st two digits are significant, third digit denotes number of zeros. R = decimal point. 1R0 = 1.0 pF 330 = 33 pF 471 = 470 pF	Tolerance A = ±0.05pF B = ±0.1pF C = ±0.25pF D = ±0.5pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%	Termination S = Standard Sn Plated Nickel C = Sn Plated Copper Non-Mag	Lead Code 1 = MicroStrip Ribbon 1S=Short Strip Ribbon 2 = Axial Ribbon 6 = Radial Wire 7 = Axial Wire leave blank if no mechanical requested	Coating Code "H" means coating requested leave blank if no coating requested	Laser Marking "L" means laser marking requested leave blank if no marking requested	Packaging 500 pc /reel "E" means horizontal orientation leave blank if no tape and reel requested

Notes:
 Coating not offered at JTI
 Packaging not specified on the part shown

Cross Reference Guide

As stated above, the key competitors for Silver Series are American Technical Ceramics (ATC), AVX, Dielectric Laboratories (DLI), and Temex.

The above cross reference information can be found at: www.johansontechnology.com/crossreference/cap.

For other competitors or new product lines from existing competitors, please contact the factory using the below contact near the end of this document.